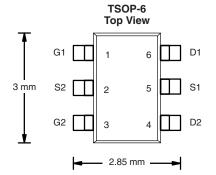


RoHS

COMPLIANT

## AM3940N-T1-PF-VB Datasheet Dual N-Channel 40 V (D-S) MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	<b>R<sub>DS(on)</sub> (</b> Ω <b>)</b>	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)		
40	0.058 at V <sub>GS</sub> = 10 V	3.6	4.0		
40	0.072 at V <sub>GS</sub> = 4.5 V	3.0	4.0		

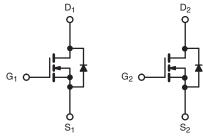


### FEATURES

- Halogen-free According to IEC 61249-2-21
  Definition
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % Rg and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

#### APPLICATIONS

- CCFL Inverter
- DC/DC Converter
- HDD



N-Channel MOSFET

N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $(T_A =$	25 °C, unless othe	rwise noted)		
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V <sub>DS</sub>	40	v	
Gate-Source Voltage	V <sub>GS</sub>	± 20	v	
	T <sub>C</sub> = 25 °C	I <sub>D</sub>	3.6	
Continuous Drain Current (T <sub>1</sub> = 150 °C)	T <sub>C</sub> = 70 °C		2.5	I
Continuous Drain Ourient (1j = 150°C)	T <sub>A</sub> = 25 °C		3.0 <sup>b, c</sup>	I
	T <sub>A</sub> = 70 °C		2.0 <sup>b, c</sup>	I
Pulsed Drain Current (10 µs Pulse Width)		I <sub>DM</sub>	20	А
Source-Drain Current Diode Current	T <sub>C</sub> = 25 °C	I <sub>S</sub>	2.0	<b>^</b>
Source-Drain Current Diode Current	T <sub>A</sub> = 25 °C	'S	1.4 <sup>b, c</sup>	I
Pulsed Source-Drain Current	I <sub>SM</sub>	20		
Single Pulse Avalanche Current		I <sub>AS</sub>	10	
Single Pulse Avalanche Energy	L = 0.1 mH	E <sub>AS</sub>	5	
	T <sub>C</sub> = 25 °C		1.3	
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	PD	0.9	w
	T <sub>A</sub> = 25 °C	' D	1.0 <sup>b, c</sup>	vv
	T <sub>A</sub> = 70 °C		0.75 <sup>b, c</sup>	Ī
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stq</sub>	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Тур.	Max.	Unit		
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 10 s	R <sub>thJA</sub>	49	62.5	°C/W		
Maximum Junction-to-Foot (Drain)	Steady-State	R <sub>thJF</sub>	30	40	0/11		

Notes:

a. Based on T\_C = 25 °C.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s. d. Maximum under steady state conditions is 120  $^{\circ}\text{C/W}.$ 

Pulse Diode Body Diode Voltage

					www.V	/Bsemi.c	
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, unless otherwise noted)							
Parameter	Symbol	Test Conditions	Min.	Typ. <sup>a</sup>	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	40			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	l <sub>D</sub> = 250 μA		49		m)//0C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	$I_D = 250 \ \mu A$		- 5.2		mV/°C	
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	1.0		2.0	V	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			100	nA	
Zana Cata Maltana Duain Cumant		$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$		10	μΑ		
On-State Drain Current <sup>b</sup>	I <sub>D(on)</sub>	$V_{DS} = 5 V, V_{GS} = 10 V$	20			А	
Drain-Source On-State Resistance <sup>b</sup>	R	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 7.0A		0.058			
	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 6.0A		0.072		Ω	
Forward Transconductance <sup>b</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 7.0A		35		S	
Dynamic <sup>a</sup>							
Input Capacitance	C <sub>iss</sub>			280		pF	
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ I}_{D} = 1 \text{ MHz}$		50			
Reverse Transfer Capacitance	C <sub>rss</sub>			22			
		$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 7.0 \text{ A}$		9.0			
Total Gate Charge	Qg			4.5		- nC	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 7.0 \text{ A}$		1.5			
Gate-Drain Charge	Q <sub>gd</sub>			1.5			
Gate Resistance	R <sub>q</sub>	f = 1 MHz	0.6	2.7	5.4	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			7	14		
Rise Time	t <sub>r</sub>	$V_{DD} = 20 \text{ V}, \text{ R}_{1} = 2 \Omega$		9	18		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 7.0 \text{ A}, V_{GEN} = 10 \text{ V}, \text{ R}_g = 1 \Omega$		16	32	1	
Fall Time	t <sub>f</sub>			8	16	1	
Turn-On Delay Time	t <sub>d(on)</sub>			12	24	ns	
Rise Time	t <sub>r</sub>	$V_{DD} = 20 V, R_1 = 2 \Omega$		10	20	1	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 7.0 \text{ A}, V_{GEN} = 4.5 \text{ V}, \text{R}_g = 1 \Omega$		13	26	-	
Fall Time	t <sub>f</sub>	, , , , , , , , , , , , , , , , , , ,		8	16	1	
Drain-Source Body Diode Characterist						I	
Continuous Source-Drain Diode Current	I <sub>S</sub>	$I_{\rm S}$ $T_{\rm C} = 25 ^{\circ}{\rm C}$ 2.6			1		
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	Ť		20		A	
	OW						

Notes:

a. Guaranteed by design, not subject to production testing.

 $V_{SD}$ 

t<sub>rr</sub>

Q<sub>rr</sub>

ta

t<sub>b</sub>

b. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

Body Diode Reverse Recovery Time

**Reverse Recovery Fall Time** 

Reverse Recovery Rise Time

Body Diode Reverse Recovery Charge

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

I<sub>S</sub> = 3 A

 $I_F = 5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_{.I} = 25 \text{ }^{\circ}\text{C}$ 

0.77

15

7.5

9

6

1.2

30

15

٧

ns

nC

ns

WWW VReomi com



- 55 °C

8

10

TC =

6

4

Coss

Capacitance

24

32

V<sub>GS</sub> = 4.5 V

 $V_{GS} = 10 V$ 

40

16

25

50

T<sub>J</sub> - Junction Temperature (°C) **On-Resistance vs. Junction Temperature** 

75

100

125

#### 50 10 V<sub>GS</sub> = 1 0 V t h r u 5 V 8 40 I<sub>D</sub> - Drain Current (A) l<sub>D</sub> - Drain Current (A) 30 6 4 20 V<sub>GS</sub> = 3 V T<sub>C</sub> = 25 °C 2 10 T<sub>C</sub> = 125 °C $V_{GS} = 2 V$ 0 0 0 2 0.0 0.5 1.0 1.5 2.0 2.5 V<sub>GS</sub> - Gate-to-Source Voltage (V) V<sub>DS</sub> - Drain-to-Source Voltage (V) **Output Characteristics Transfer Characteristics** 0.100 400 Ciss 0.080 320 $R_{DS(on)}$ - On-Resistance ( $\Omega$ ) $V_{GS} = 4.5 V$ C - Capacitance (pF) 0.060 240 $V_{GS} = 10 V$ 0.040 160 0.020 80 $C_{\text{rss}}$ 0.000 0 30 0 10 20 40 50 0 8 I<sub>D</sub> - Drain Current (A) $\rm V_{\rm DS}$ - Drain-to-Source Voltage (V) **On-Resistance vs. Drain Current** 10 2.0 $I_D = 3 A$ $I_D = 6 A$ V<sub>GS</sub> - Gate-to-Source Voltage (V) 1.7 8 V<sub>DS</sub> = 20 V R<sub>DS(on)</sub> - On-Resistance (Normalized) 6 1.4 $V_{DS} = 10 V$ $V_{DS} = 30 V$ 1.1 4 0.8 2 0 0.5 2.1 - 50 - 25 0 0.0 4.2 6.3 8.4 10.5

#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

服务热线:400-655-8788

Q<sub>q</sub> - Total Gate Charge (nC)

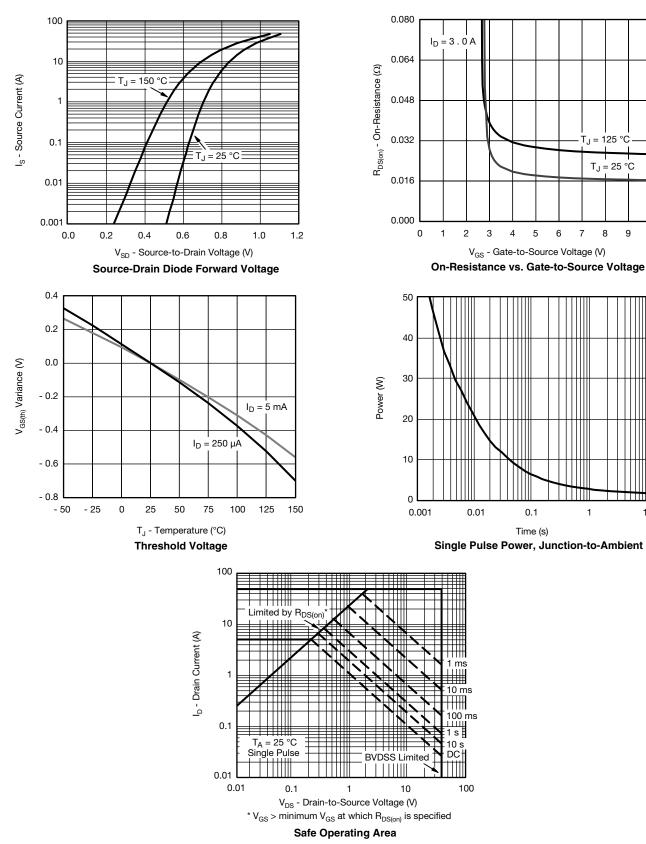
Gate Charge

150



10

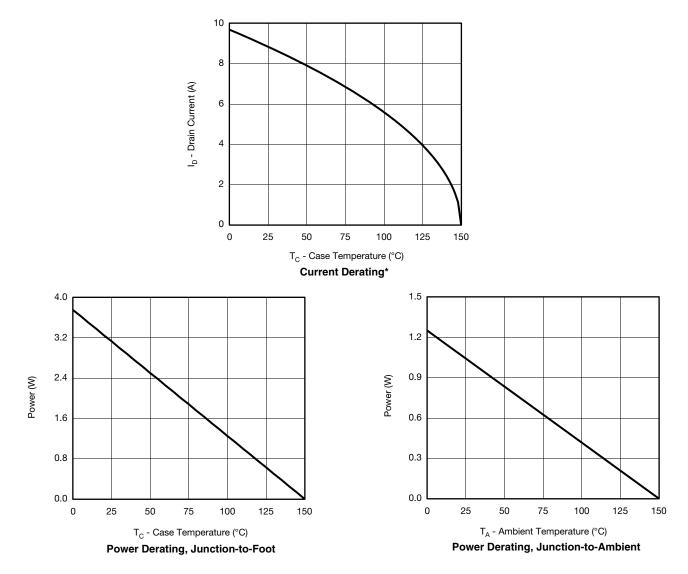
10



#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



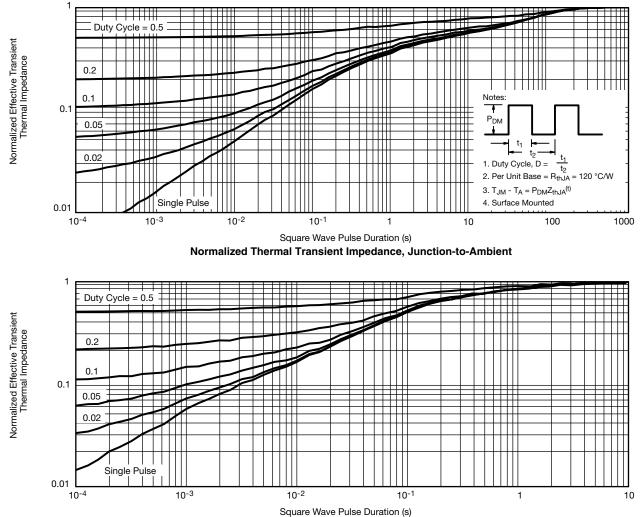
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



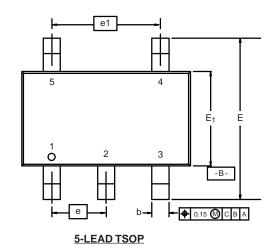
#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

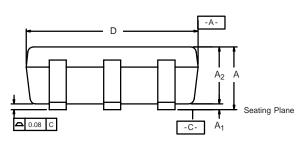


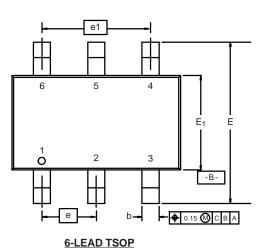
Normalized Thermal Transient Impedance, Junction-to-Foot

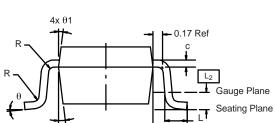


TSOP: 5/6–LEAD JEDEC Part Number: MO-193C









(L<sub>1</sub>)

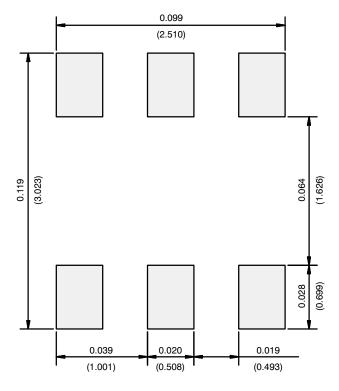
4x θ1

	MILLIMETERS			INCHES			
Dim	Min	Nom	Max	Min	Nom	Мах	
Α	0.91	-	1.10	0.036	-	0.043	
A <sub>1</sub>	0.01	-	0.10	0.0004	-	0.004	
A <sub>2</sub>	0.90	-	1.00	0.035	0.038	0.039	
b	0.30	0.32	0.45	0.012	0.013	0.018	
С	0.10	0.15	0.20	0.004	0.006	0.008	
D	2.95	3.05	3.10	0.116	0.120	0.122	
E	2.70	2.85	2.98	0.106	0.112	0.117	
E <sub>1</sub>	1.55	1.65	1.70	0.061	0.065	0.067	
е	0.95 BSC			0.0374 BSC			
e <sub>1</sub>	1.80	1.90	2.00	0.071	0.075	0.079	
L	0.32	-	0.50	0.012	-	0.020	
L <sub>1</sub>	0.60 Ref			0.024 Ref			
L <sub>2</sub>	0.25 BSC			0.010 BSC			
R	0.10	-	-	0.004	-	-	
θ	0°	4°	8°	0°	4°	8°	
θ <sub>1</sub>	7° Nom			7° Nom			
ECN: C-06593-Rev. I, 18-Dec-06 DWG: 5540							

## AM3940N-T1-PF-VB



### **RECOMMENDED MINIMUM PADS FOR TSOP-6**



Recommended Minimum Pads Dimensions in Inches/(mm)



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